



ThinFlex

Distributed by:



ThinFlex Corporation

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ThinFlex-A, A-5005RD
Adhesiveless Double Sided Copper Clad Laminate
(Halogen Free)

ThinFlex-A, A-5005RD is an adhesiveless double-sided (D/S) copper clad laminate, using UBE TPI film and laminated with RA copper foil on both sides. ThinFlex-A, A-5005RD adhesiveless D/S composites are designed for a wide variety of flexible circuit applications which require advanced material performance, temperature resistance, fine pitch, and high reliability.

1. Product Characteristics:

- * Excellent dimensional stability
* Excellent flexibility
* Finer line etching capability
* Low moisture absorption
* Excellent flammability
* Excellent chemical resistance
* Excellent thermal, mechanical, and electrical properties

2. Specifications:

A - 50 05 R D

Diagram showing arrows from 'A-5005RD' to a table with columns: Product (A: D/S FCCL), Thickness of PI (50: 5.0 mil), Thickness of Cu (05: 0.5oz), Cu Type (R: RA), Structure (Double-sided), and Supply Size (W: 458 ± 1mm; L: 610 ± 2mm (sheet type)).

*Other thicknesses and dimensions are available on customers' demand.



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3. Construction:

Copper foil
Polyimide film
Copper foil

4. Properties:

Test item	Unit	Specification	Typical Value	Test Method	
Peel Strength					
As Received	Kgf/cm	≥ 1.0	2.0	IPC-TM650 2.4.9 B	
Solder Float	Kgf/cm	≥ 1.0	2.0	IPC-TM650 2.4.13 B	
After Temp. Cycling	Kgf/cm	≥ 1.0	2.0	IPC-TM650 2.4.9	
Chemical Resistance	Kgf/cm	≥ 1.0	2.0	IPC-TM650 2.3.2	
Tensile Strength (Base Film)	Kg/mm ²	≥ 30	32	IPC-TM-650 2.4.19	
Elongation (Base Film)	%	≥ 85	106	IPC-TM-650 2.4.19	
Tensile Modulus (Base Film)	Kg/mm ²	≥ 550	580	ASTM D882	
Initial Tear Strength (Base Film)	g	≥ 4200	4400	IPC-TM-650 2.4.16	
Propagation Tear Strength (Base Film)	g	≥ 65	68	IPC-TM-650 2.4.17.1	
Flexural Endurance, MIT					
M.D.	Cycles	NA	NA	JIS-C 6471, 0.8mmR, 0.5kg	
T.D.	Cycles	NA	NA	JIS-C 6471, 0.8mmR, 0.5kg	
Electrical Properties					
Surface Resistance	Ω	~10 ¹¹	~10 ¹²	IPC-TM650 2.5.17	
Volume Resistance	Ω-cm	~10 ¹²	~10 ¹⁴	IPC-TM650 2.5.17	
Insulation Resistance	Ω	~10 ⁹	~10 ¹⁰	IPC-TM650 2.6.3.2	
Dielectric Strength	kV/mil	≥ 6.9	7.0	ASTM-D149	
Dielectric Constant	-	≤ 3.3	3.2	IPC-TM650 2.5.5.3	
Dissipation factor	-	≥ 0.002	0.003	IPC-TM650 2.5.5.3	
Physical and Thermal Properties					
Dimensional Stability	M.D.	%	-0.1~0.1	-0.08~0.08	IPC-TM650 2.2.4C
	T.D.	%	-0.1~0.1	-0.08~0.08	IPC-TM650 2.2.4C
CTE		ppm/°C	≤ 19.3	19.0	ThinFlex
T _g		°C	≥ 350	355	ThinFlex
Solder Float	10sec at 288°C (550°F)	-	Pass	Pass	IPC-TM650 2.4.13
Moisture Absorption Test		%	≤ 1.1	1.0	IPC-TM650 2.6.2
Chemical Resistance-single		-	Pass	Pass	IPC-TM650 2.3.2
Thickness tolerance		um	161±10%	160.8	ThinFlex
UL Flame Class		-	≤ V-0	V-0	UL94

* Above data are typical values, and are not guaranteed values.



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5. Storage:

ThinFlex-A, A-5005RD will meet its shelf-life for at least 12 months after arrival at the user's factory when stored in the original packaging at temperatures of below 25°C and below 70% humidity. The products do not need refrigeration and should not be frozen.

Note: The information and data contained in this technical literature is believed to be accurate and is offered in good faith for the benefit of the user. The user should make his own tests to verify the suitability of this product for any application before its use. All data are typical values only and subject to change without notice.

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